



Thickness=1.60mm

PC BOARD LAYOUT COMPONENT SIDE SHOWN

NOTES:

ELECTRICAL:

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 35 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN. @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE t=0.35mm.
3. PLATING : GOLD PLATING OVER NICKEL.
4. OPERATING LIFE : 750 CYCLES MIN.
5. PCB RETENTION PRE-SOLDER : 1 LB MIN.
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO +85°C.
2. OPERATION: -40°C TO +85°C.
3. WAVE SOLDERING TEMPERATURE: 230°~250°(3~5 SECONDS)
4. ROHS COMPLIANT.

MATES WITH MODULAR PLUG CONFORMING TO

FCC PART 68, SUBPART F.

CUL FILE NO. E163191

PART NUMBER	GOLD PLATING	CONTACTS
E5386-E00212-L	6u"	6
E5388-E00212-L	6u"	8
E5388-E00213-L	15u"	8
E5388-E00214-L	30u"	8

DETACHED LISTS	
← (MM)	→ (MM)
TOLERANCES EXCEPT AS NOTED	
MM	±
0 ± 0.2	±
.00 ± 0.15	±
.000 ± 0.075	±
ANGLES ± 0.5	



THIRD ANGLE PROJECTION



RoHS Compliant

DRG. JEFF CHI DATE 06/28/06

SCALE : 3 : 1

PULSE RISE ELECTRONIC CO., LTD

TITLE 11.5 SIDE ENTRY 8P
FCC DEEP TYPE

DRAWING NO. CE533096-01

/PART NO. SEE NOTES

DO NOT SCALE DRAWING

SIZE REV

A3 0

SHEET 1 OF 1